

Koneru Ramakrishna

List of Publications by Year in descending order

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Version: 2024-02-01

5
papers

27
citations

3311381

1
h-index

3475538

1
g-index

5
all docs

5
docs citations

5
times ranked

23
citing authors

#	ARTICLE	IF	CITATIONS
1	A Compact Approach to On-Chip Interconnect Heat Conduction Modeling Using the Finite Element Method. Journal of Electronic Packaging, Transactions of the ASME, 2008, 130, .	1.8	25
2	Nanoscale conformable coatings for enhanced thermal conduction of carbon nanotube films. , 2012, , .		2
3	In Memoriam Prof. Avram Bar-Cohen. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2021, 11, 1153-1155.	2.5	0
4	In Memoriam - A Tribute: Prof. Avram Bar-Cohen. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2021, 11, 1519-1523.	2.5	0
5	In Memoriam Prof. Avram Bar-Cohen. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2021, 11, 1747-1749.	2.5	0